Specification

Innolume GmbH Konrad-Adenauer-Allee 11 44263 Dortmund, Germany

BOA1300060YY350MXXXX

Fiber Coupled Booster Semiconductor Optical Amplifier



Features:

- High output power >350mW @ 1300nm
- High saturation output power (22dBm)
- Proprietary anti-reflection coating technology enabling high reliability
- Polarization maintaining PM980 (PM1300 optional) fiber or HI1060 fiber
 - 900um loose tube on fiber (optional)

Applications:

- LiDAR
- Datacom
- Swept sources, tunable lasers
- Optical coherence tomography (OCT)

Recommended Operating Conditions				
@ CW, Tcase=25°C				
Parameter	Min.	Тур.	Max.	Unit
Chip Temperature	20	25	40	°C
Forward Current		2000	3000	mA
Output Power in Amplification Mode			350	mW
Input Optical Power	-20	10	15	dBm

Gain Characteristics				
@ CW, 25°C, 2000mA, with input signal 10dBm, 1300nm				
Parameter	Min.	Тур.	Max.	Unit
Forward Current @ 350mW			3000	mA
Saturation Output Power @ -3dB	17	22		dBm
Gain	12	16		dB
Small Signal Gain @ Pin=-20dBm	24	28		dB
Peak Wavelength	1290	1300	1310	nm
Bandwidth @ -3dB		60		nm
Noise Figure @ Pin=-20dBm		6.4		dB

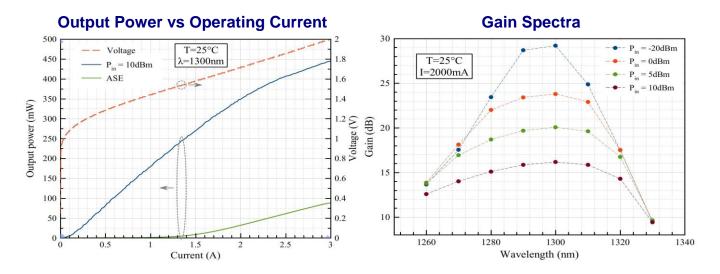
Amplified Spontaneous Emission (ASE) Characteristics				
@ CW, 25°C, 2000mA, no input signal				
Parameter	Min.	Тур.	Max.	Unit
Output Power (each port)		30		mW
Forward Voltage		1.7	2.4	V
Mean Wavelength		1201		nm
Bandwidth (FWHM)		16		nm
Ripples* (RMS)		0.05	1	dB
Polarisation Extinction Ratio (PER)	12	16		dB
Polarization		TE		

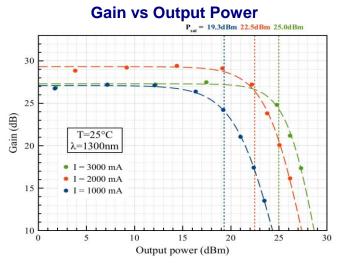
^{* -} measured in 1nm span around spectrum maximum with 20pm resolution.

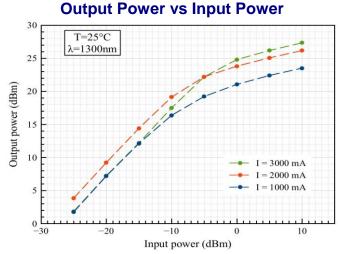


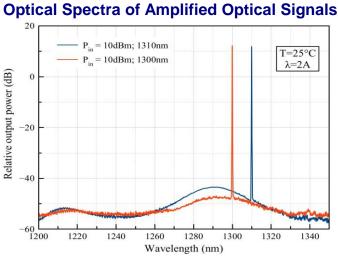
Typical Performance (for reference only)

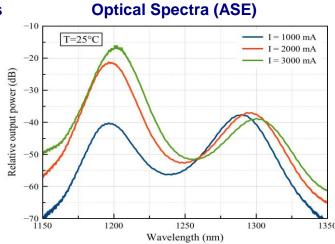
@ CW, Tcase=25°C











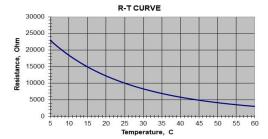




Absolute Maximum Ratings			
Parameter	Min	Max	Unit
Output Optical Power		1000	mW
Input Optical Power		20	dBm
Forward Current		4000	mA
Reverse Voltage		2	V
TEC Current		3	Α
TEC Voltage		4	V
Chip Operating Temperature	5	50	°C
Case Operating Temperature	0	50	°C
Storage Temperature	0	50	°C
Pin Soldering Temperature (max 10 sec, max case temperature 120°C)		300	°C
Fiber Band Radius	3		cm

Fiber specification

Thermistor specification			Fiber speci
Parameters	Value	Unit	Parameters
Туре	NTC		Fiber Type
Resistance @ 25°C	10±0.1	kOhm	Numerical Apert
Beta 25-85°C	3435±1%	K	Cut-off Waveler

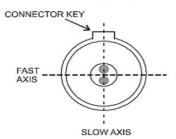


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Fiber Type	HI1060	PM980	
Numerical Aperture (Typical)	0.14	0.12	
Cut-off Wavelength	920±50	900±70	nm
Mode-Field Diameter	6.2±0.3 @1060nm	6.6±0.3 @1060nm	μm
Cladding Diameter	125±1	125±1	μm
Coating Diameter	245±15	245±15	μm
Loose Tube Diameter (optional)	900	900	μm
Connector	FC/APC	FC/APC	
Key	narrow	narrow	

Value

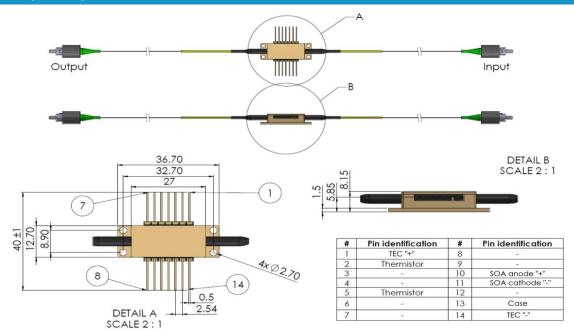
Value

Unit



The output light is polarized along the slow axis of PM fiber.

Dimensions (in mm)



Safety and Operating Instructions

The light emitted from this device is invisible and can be harmful to the human eye. Avoid looking directly into the fiber connector when the device is in operation. Proper laser safety eyewear must be worn during operation with open connector.

Absolute Maximum Ratings may be applied to the device for short period of time only. Exposure to maximum ratings for extended period of time or exposure to more than one maximum rating may cause damage or affect the reliability of the device. Operating the device outside of its maximum ratings may cause device failure or a safety hazard. Power supplies used with the component must be employed such that the maximum forward current cannot be exceeded. A proper heatsink for the device on thermal radiator is required. The device must be mounted on radiator with 4 screws (bolt down in X-style fashion with initial torque set to 0.075Nm and final X-style bolt down at 0.15Nm) or with clamps. The deviation from flatness of radiator surface must be less than 0.05mm. It's recommended using of Indium foil or thermal conductive and soft material between bottom of the case and heatsink for thermal interface. It's undesirable to use thermal grease for this.

It is highly recommended to use a mount with additional temperature stabilization for the module's case. Even short-term exceeding of the Case Operating Temperature during operation can cause damage to the device. Avoid back reflection to the device. It may give impact on the device performance in aspects of spectrum and power stability. It also may cause fatal facet damage. Using of optical isolators is highly recommended to block back reflection. Do not pull the fiber. Do not bend a fiber with a radius smaller than 3 cm. Fiber tip should always be protected from any contamination or damage during the process of installation. After removing the dust-preventing cap covered at fiber tip, carefully clean fiber tip by wiping through one direction using optical lens cleaning paper or cotton swab dabbed with Iso-Propanol or Ethyl alcohol. Operate the device with clean fiber connector only.

ESD PROTECTION - Electrostatic discharge is the primary cause of unexpected product failure. Take extreme precaution to prevent ESD. During device installation, ESD protection has to be maintained - use wrist straps, grounded work surfaces and rigorous antistatic techniques when handling the product.













Specification

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Part-number Identification

BOA1300060HI350MXXXX -> 350mW output power at 1300nm mean wavelength, 60nm bandwidth, HI-1060 fiber BOA1300060PM350MLXXX -> 350mW output power at 1300nm mean wavelength, 60nm bandwidth, PM-980 fiber, with loose tube

NOTE: Innolume product specifications are subject to change without notice